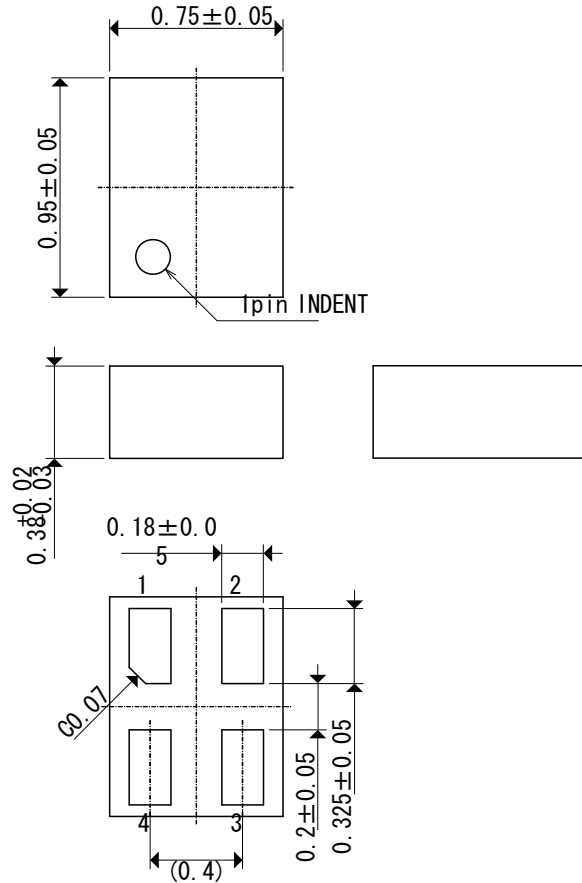


Packaging Information / Reference Pattern Layout Dimensions

●USPN-4B02

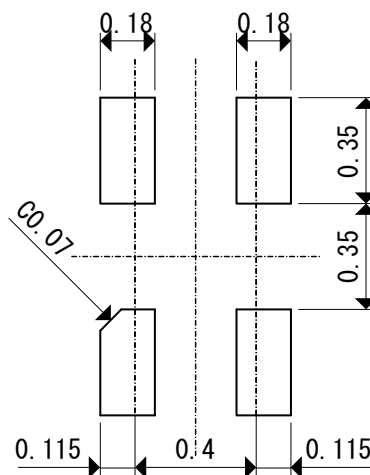
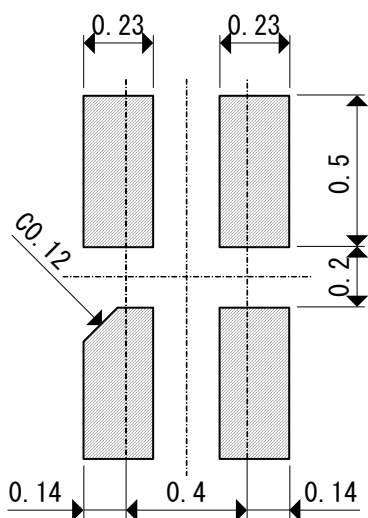
■Packaging Information

Unit: mm



■Reference Pattern Layout Dimension

Reference metal mask design



• Solder thickness: 120 μm (Ref.)